



MBF15T65PEH

650V Field Stop IGBT

General Description

This IGBT is produced using advanced MagnaChip's Field Stop Trench IGBT Technology, which provides high performance, excellent quality and high ruggedness.

This device is for motor control.

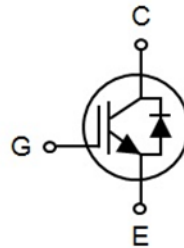
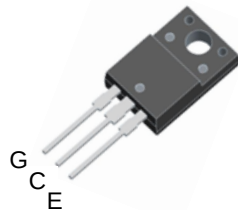
Features

- High ruggedness for motor control
- $V_{CE(sat)}$ positive temperature coefficient
- Very soft, fast recovery anti-parallel diode
- Low EMI
- Maximum junction temperature 175°C

Applications

- Inverter for motor control

TO-220F



G : Gate
C : Collector
E : Emitter

Package outline and symbol

Maximum Rating

Parameter	Symbol	Rating	Unit
Collector-emitter voltage	V_{CE}	650	V
DC collector current, limited by T_{vjmax}	I_C	$T_C=25^{\circ}C$ 19	A
		$T_C=100^{\circ}C$ 12	A
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpuls}	38	A
Diode forward current limited by T_{vjmax}	I_F	$T_C=25^{\circ}C$ 19	A
		$T_C=100^{\circ}C$ 12	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpuls}	38	A
Gate-emitter voltage	V_{GE}	± 20	V
Power dissipation	P_D	$T_C=25^{\circ}C$ 48	W
		$T_C=100^{\circ}C$ 24	W
Short circuit withstand time $V_{CC} \leq 360V, V_{GE} = 15V, T_{vj} = 150^{\circ}C$	tsc	5	μs
Operating Junction temperature range	T_{vj}	-55~175	$^{\circ}C$
Storage temperature range	T_{stg}	-55~175	$^{\circ}C$

Thermal Characteristic

Parameter	Symbol	Rating	Unit
Thermal resistance junction-to-ambient	$R_{\theta JA}$	62	$^{\circ}C/W$
Thermal resistance junction-to-case for IGBT	$R_{\theta JC}$	3.1	
Thermal resistance junction-to-case for Diode	$R_{\theta JC}$	5.2	

Ordering Information

Part Number	Marking	Temp. Range	Package	Packing	RoHS Status
MBF15T65PEH	15T65PEH	-55~175°C	TO-220F	Tube	Halogen Free

Electrical Characteristic ($T_{vj} = 25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Static Characteristic						
Collector-emitter breakdown voltage	BV_{CES}	$I_C = 2\text{mA}$, $V_{GE} = 0\text{V}$	650	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 15\text{A}$, $V_{GE} = 15\text{V}$	$T_{vj} = 25^{\circ}\text{C}$	1.80	2.20	V
			$T_{vj} = 175^{\circ}\text{C}$	2.10		
Diode forward voltage	V_F	$V_{GE} = 0\text{V}$, $I_F = 15\text{A}$	$T_{vj} = 25^{\circ}\text{C}$	1.85	2.30	V
			$T_{vj} = 175^{\circ}\text{C}$	1.95		
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$, $I_C = 0.5\text{mA}$	5.0	6.0	7.0	V
Zero gate voltage collector current	I_{CES}	$V_{CE} = 650\text{V}$, $V_{GE} = 0\text{V}$, $T_{vj} = 25^{\circ}\text{C}$	-	-	20	μA
Gate-emitter leakage current	I_{GES}	$V_{GE} = 20\text{V}$, $V_{CE} = 0\text{V}$	-	-	± 100	nA
Dynamic Characteristic						
Total gate charge	Q_g	$V_{CE} = 520\text{V}$, $I_C = 15\text{A}$, $V_{GE} = 15\text{V}$	-	61		nC
Gate-emitter charge	Q_{ge}		-	11		
Gate-collector charge	Q_{gc}		-	35		
Input capacitance	C_{ies}	$V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$, $f = 1\text{MHz}$	-	1129	-	pF
Reverse transfer capacitance	C_{oes}		-	57	-	
Output capacitance	C_{res}		-	31	-	
Switching Characteristic						
Turn-on delay time	$t_{d(on)}$	$V_{GE} = 15\text{V}$, $V_{CC} = 400\text{V}$, $I_C = 15\text{A}$, $R_G = 10\Omega$, Inductive Load, $T_{vj} = 25^{\circ}\text{C}$	-	19	-	ns
Rise time	t_r		-	27	-	
Turn-off delay time	$t_{d(off)}$		-	128	-	
Fall time	t_f		-	32	-	
Turn-on switching energy	E_{on}		-	270	-	μJ
Turn-off switching energy	E_{off}		-	86	-	
Total switching energy	E_{ts}		-	356	-	
Turn-on delay time	$t_{d(on)}$	$V_{GE} = 15\text{V}$, $V_{CC} = 400\text{V}$, $I_C = 15\text{A}$, $R_G = 10\Omega$, Inductive Load, $T_{vj} = 175^{\circ}\text{C}$	-	17	-	ns
Rise time	t_r		-	29	-	
Turn-off delay time	$t_{d(off)}$		-	150	-	
Fall time	t_f		-	130	-	
Turn-on switching energy	E_{on}		-	342	-	μJ
Turn-off switching energy	E_{off}		-	288	-	
Total switching energy	E_{ts}		-	630	-	
Reverse recovery time	t_{rr}	$I_F = 15\text{A}$, $di_F/dt = 200\text{A}/\mu\text{s}$, $T_{vj} = 25^{\circ}\text{C}$	-	150	-	ns
Reverse recovery current	I_{rr}		-	5.2	-	A
Reverse recovery charge	Q_{rr}		-	460	-	nC
Reverse recovery time	t_{rr}	$I_F = 15\text{A}$, $di_F/dt = 200\text{A}/\mu\text{s}$, $T_{vj} = 175^{\circ}\text{C}$	-	207	-	ns
Reverse recovery current	I_{rr}		-	6.1	-	A
Reverse recovery charge	Q_{rr}		-	790	-	nC

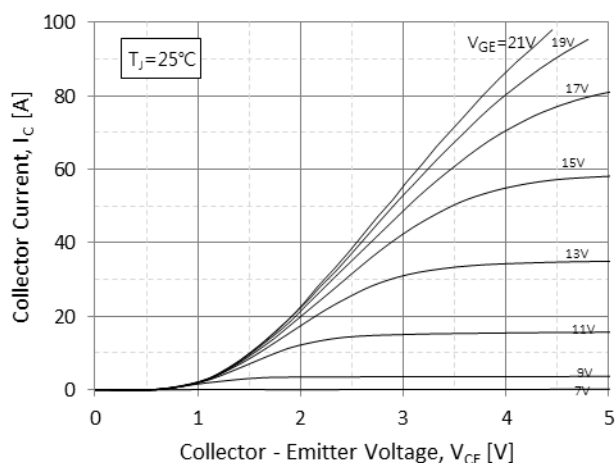


Fig.1 Typical Output Characteristics($T_J=25^\circ\text{C}$)

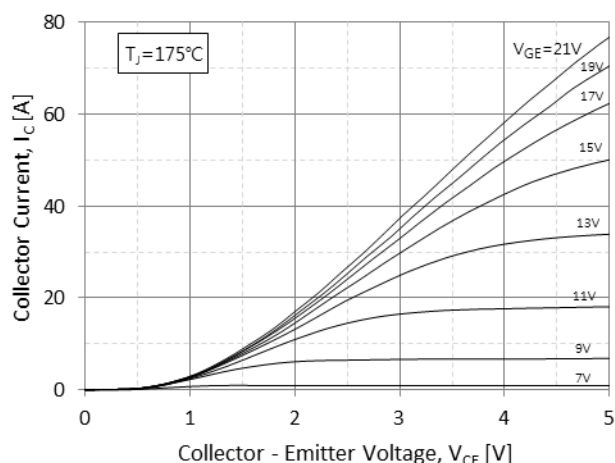


Fig.2 Typical Output Characteristics($T_J=175^\circ\text{C}$)

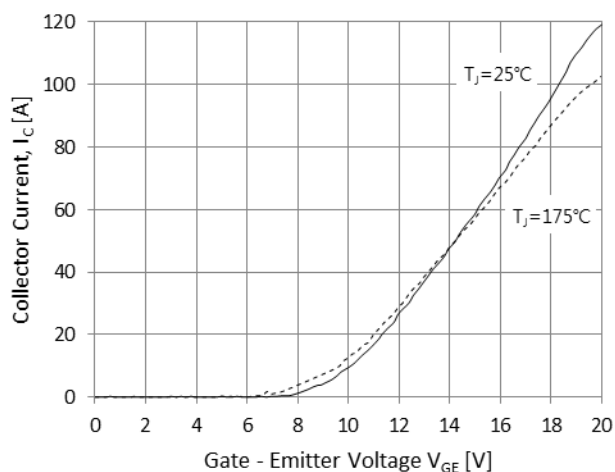


Fig.3 Typical Transfer Characteristics

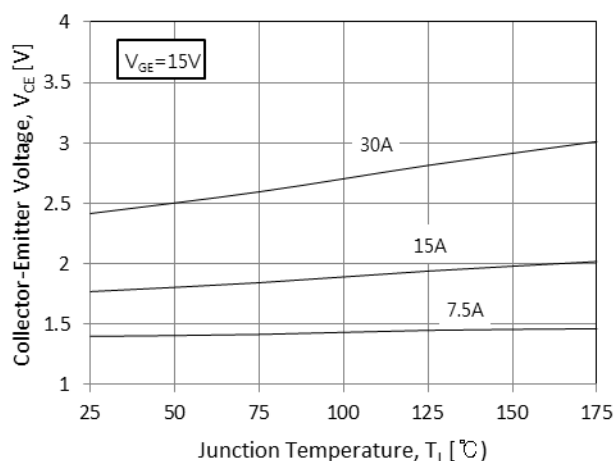


Fig.4 Typical Collector-Emitter Saturation Voltage -Junction Temperature

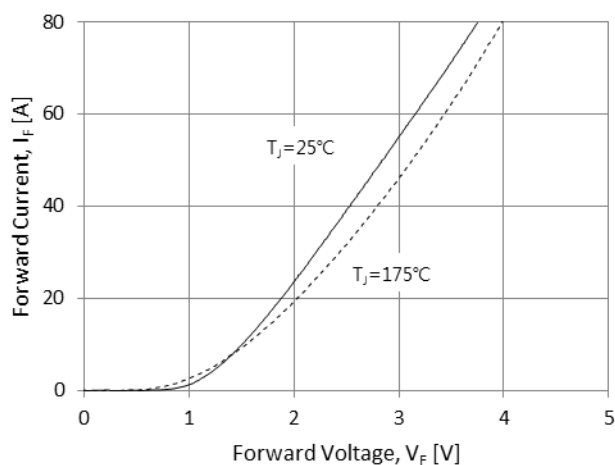


Fig.5 Diode Forward Characteristics

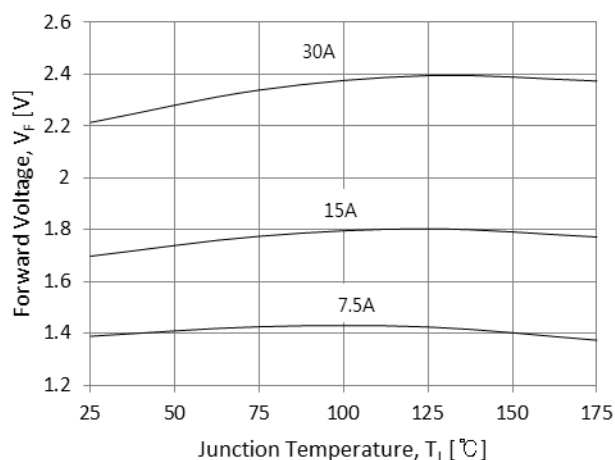


Fig.6 Diode Forward-Junction Temperature

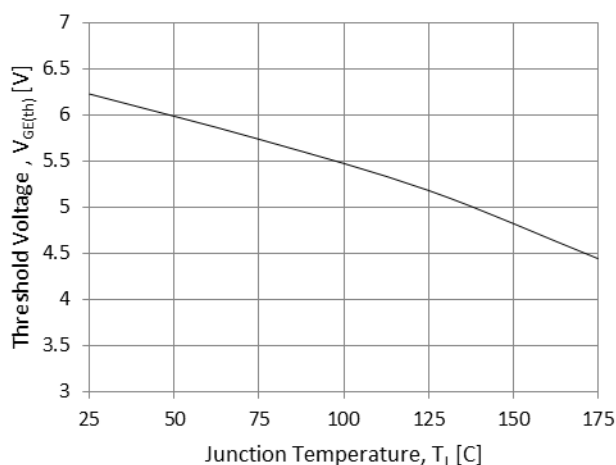


Fig.7 Threshold Voltage-Junction Temperature

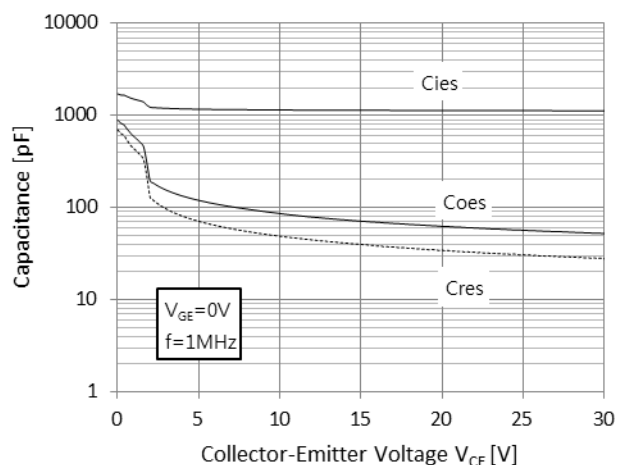


Fig.8 Typical Capacitance

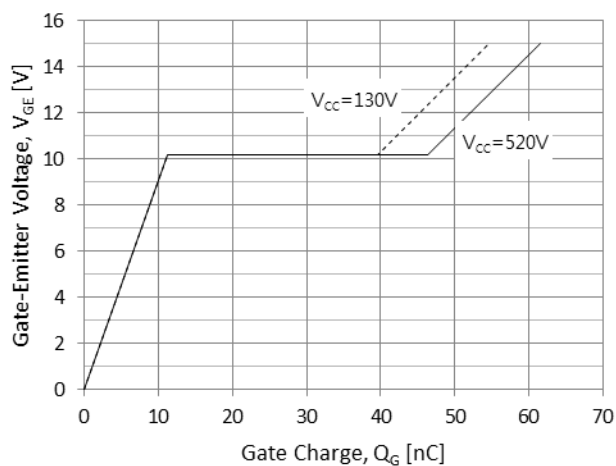


Fig.9 Typical Gate Charge

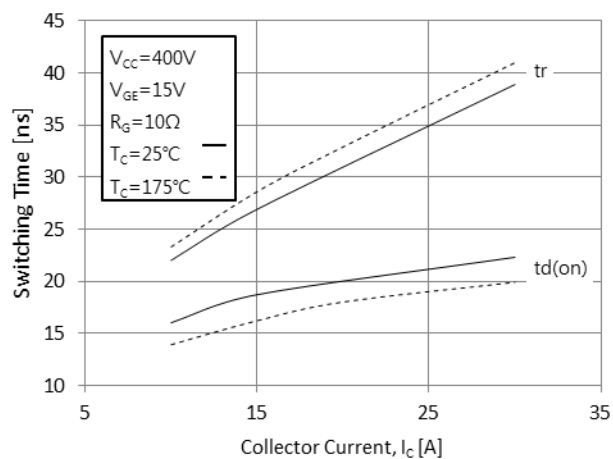


Fig.10 Typical Turn on-Collector Current

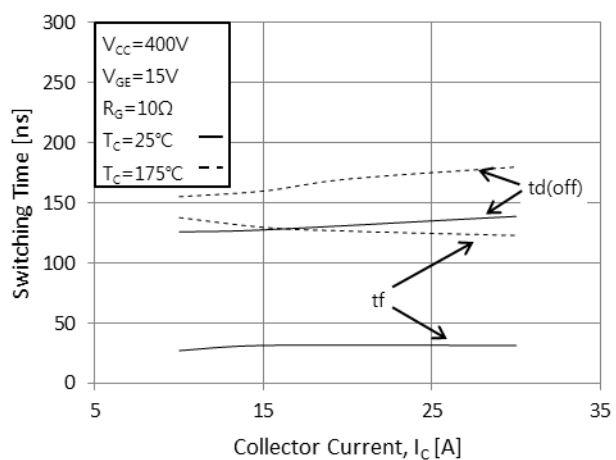


Fig.11 Typical Turn off-Collector Current

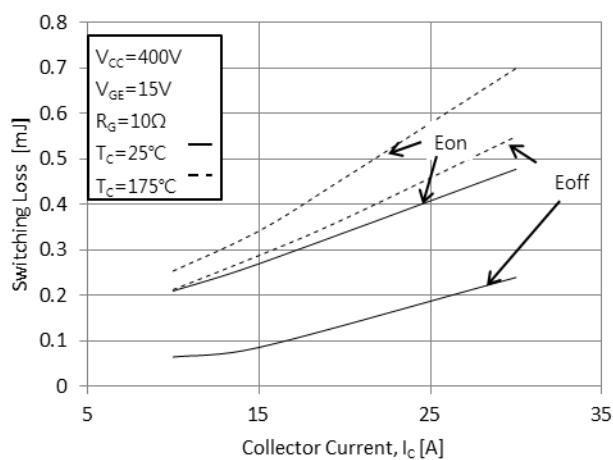


Fig.12 Switching Loss-Collector Current

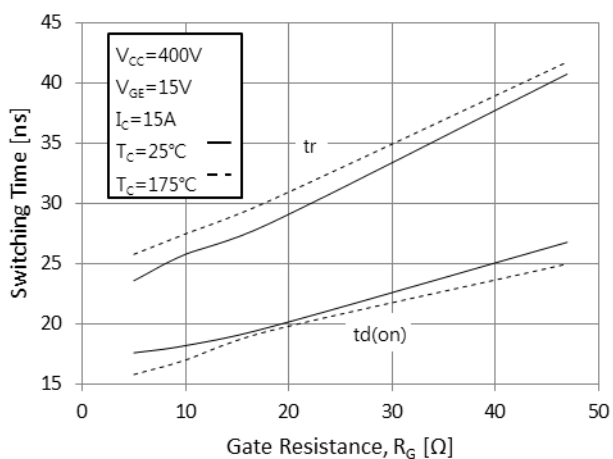


Fig.13 Turn on Characteristics-Gate Resistance

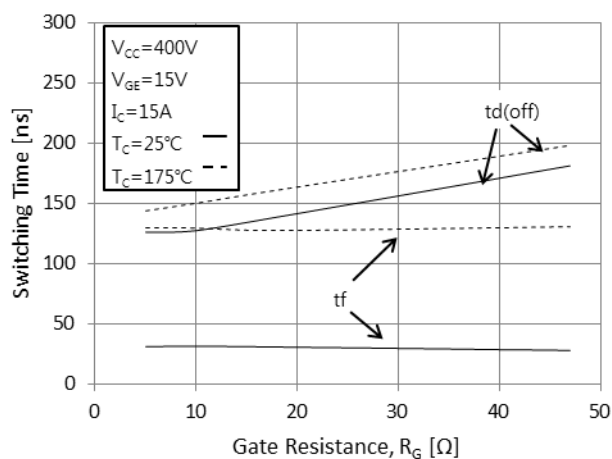


Fig.14 Turn off Characteristics-Gate Resistance

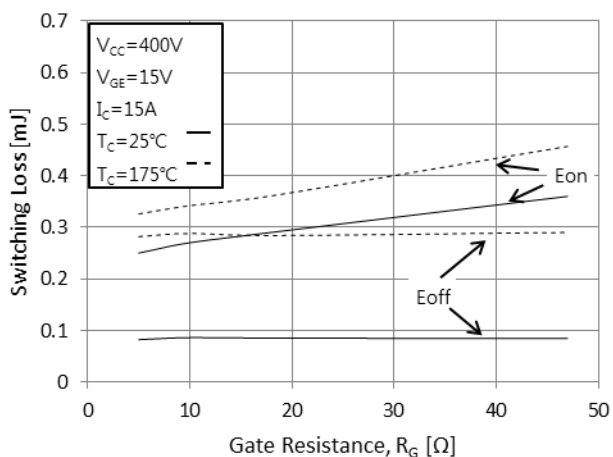


Fig.15 Switching Loss-Gate Resistance

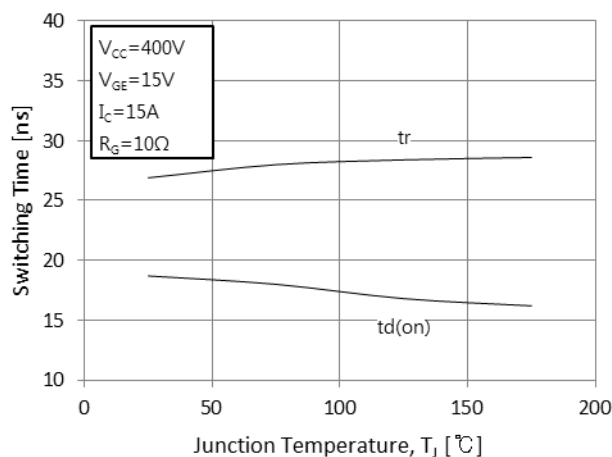


Fig.16 Turn on Characteristics-Junction Temperature

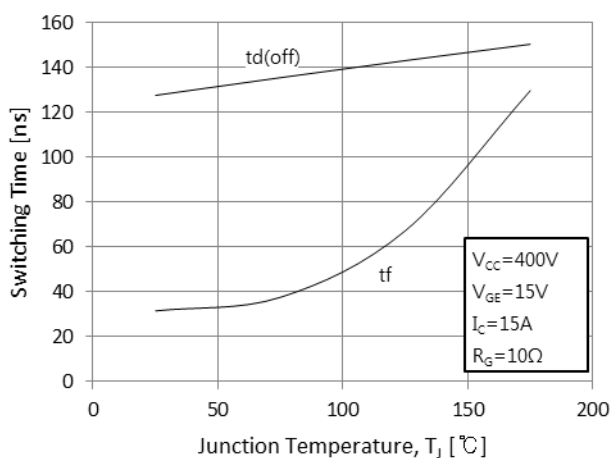


Fig.17 Turn off Characteristics-Junction Temperature

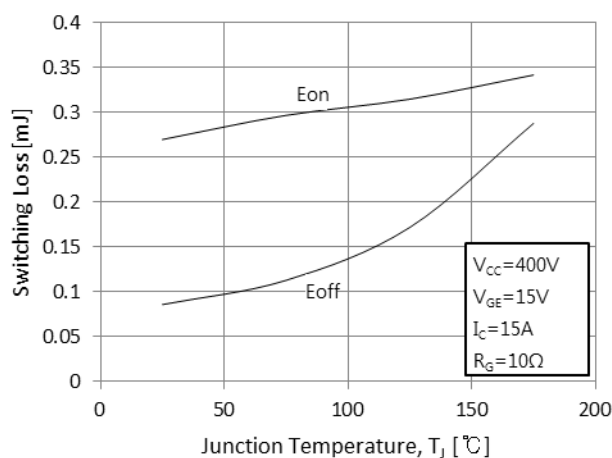


Fig.18 Switching Loss-Junction Temperature

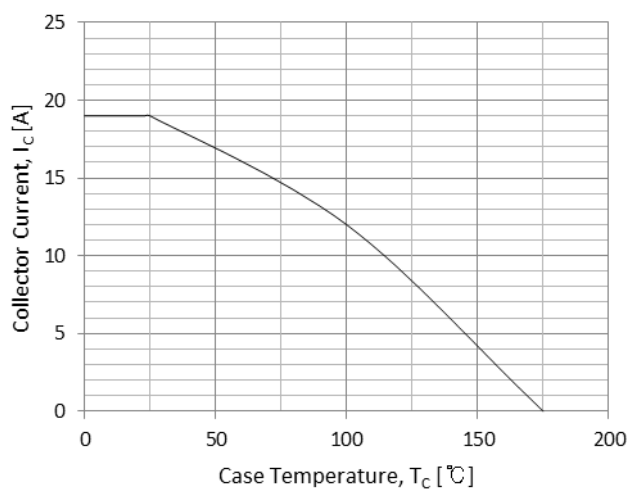
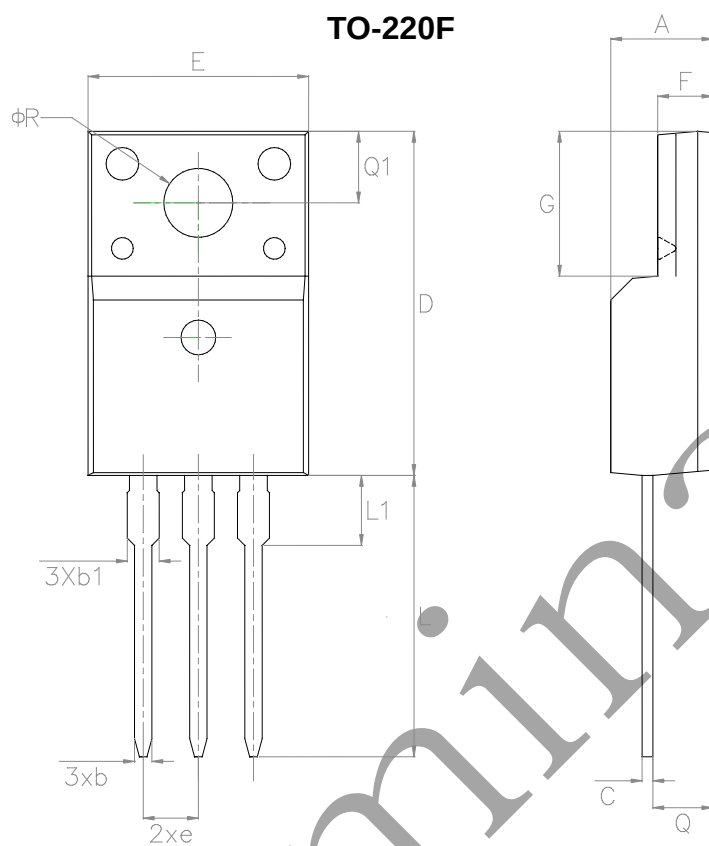


Fig.19 Case Temperature-Collector Current

Package outline dimension



Symbol	Min	Nom	Max
A	4.50	-	4.93
b	0.63	-	0.91
b1	1.15	-	1.47
C	0.33	-	0.63
D	15.47	-	16.13
E	9.60	-	10.71
e	2.54 BSC		
F	2.34	-	2.84
G	6.48	-	6.90
L	12.24	-	13.72
L1	2.79	-	3.67
Q	2.52	-	2.96
Q1	3.10	-	3.50
ϕR	3.00	-	3.55

DISCLAIMER:

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